IN THE CLAIMS

Presented below is a complete list of claims with changes marked up:

1. (Currently Amended) A package comprising:

each of the plurality of traces having first and second ends, the first ends of the plurality of traces located at a first side of the area of the substrate and second ends of the plurality of traces located at a second side of the area opposite the first side;

a plurality of wires coupling the plurality of traces to form a coil by having each of the plurality of wires coupling a first end of one trace of the plurality of traces to a second end of another of the plurality of traces located adjacent to the one trace; and a resistor, on the surface of the substrate, coupled to the coil.

- 2. (Original) The package of claim 1 wherein the plurality of traces are substantially parallel to each other.
 - 3. (Canceled)
 - 4. (Original) The package of claim 1 wherein the traces are welded to the wires.
- 5. (Original) The package of claim 1 wherein the traces have a length of 2 mm and a pitch of 1 mm.

6. - 15. (Canceled)

26. (Currently Amended) A package comprising:

a coil, the coil including a plurality of loops, each loop including a trace traces on a surface of the substrate and a plurality of wire bonds, each wire bond coupling one trace to another trace coupled to one end of the trace and an end of an adjacent trace, wherein a magnetic field is created when current flows through the coil; and a resistor, on the surface of the substrate, coupled to the coil.

17. (Currently Amended) A package comprising: a substrate;

a plurality of traces <u>on a surface of the substrate</u> having first and second ends, the first ends of the plurality of traces located at a first side of the substrate and the second ends of the plurality of traces located at a second side of the substrate opposite to the first side;

a plurality of wires, each wire coupling a first end of one trace of the plurality of traces to a second end of another trace of the plurality of traces located adjacent to the one trace to form a coil loop, with loops completed together forming a coil and linked together by a magnetic flux created in response to current flowing through the loops of the coil; and

a resistor, on the surface of the substrate, coupled to the coil.

Rule 1.12

The package of claim 1, wherein the traces are wire-bonded to the

wires.